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REVISION HISTORY

6/14—Rev. A to Rev. B

Changes to Features Section.....	1
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11/10—Rev. 0 to Rev. A

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10/09—Revision 0: Initial Version

SPECIFICATIONS

$V_{CC} = 5\text{ V} \pm 10\%$; all specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 1.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER						
Differential Output Voltage	V_{OD}			5.0	V	$R = \infty$, see Figure 11
		2.0		5.0	V	$V_{CC} = 5\text{ V}$, $R = 50\ \Omega$ (RS-422), see Figure 11
		1.5		5.0	V	$R = 27\ \Omega$ (RS-485), see Figure 11
		1.5		5.0	V	$V_{TST} = -7\text{ V to } +12\text{ V}$, see Figure 12, $V_{CC} = 5\text{ V} \pm 5\%$
$\Delta V_{OD} $ for Complementary Output States				0.2	V	$R = 27\ \Omega$ or $50\ \Omega$, see Figure 11
Common-Mode Output Voltage	V_{OC}			3.0	V	$R = 27\ \Omega$ or $50\ \Omega$, see Figure 11
$\Delta V_{OC} $ for Complementary Output States				0.2	V	$R = 27\ \Omega$ or $50\ \Omega$
Output Short-Circuit Current				250	mA	$-7\text{ V} \leq V_O \leq +12\text{ V}$
V_{OUT}						
CMOS Input Logic Threshold Low	V_{INL}		1.4	0.8	V	
CMOS Input Logic Threshold High	V_{INH}	2.0	1.4		V	
Logic Input Current (DE, DI)				± 1.0	μA	
RECEIVER						
Differential Input Threshold Voltage	V_{TH}	-0.2		+0.2	V	$-7\text{ V} \leq V_{CM} \leq +12\text{ V}$
Input Voltage Hysteresis	ΔV_{TH}		70		mV	$V_{CM} = 0\text{ V}$
Input Resistance		12			k Ω	$-7\text{ V} \leq V_{CM} \leq +12\text{ V}$
Input Current (A, B)				1	mA	$V_{IN} = 12\text{ V}$
				-0.8	mA	$V_{IN} = -7\text{ V}$
Logic Enable Input Current (\overline{RE})				± 1	μA	
CMOS Output Voltage Low	V_{OL}			0.4	V	$I_{OUT} = +4.0\text{ mA}$
CMOS Output Voltage High	V_{OH}	4.0			V	$I_{OUT} = -4.0\text{ mA}$
Short-Circuit Output Current		7		85	mA	$V_{OUT} = \text{GND or } V_{CC}$
Three-State Output Leakage Current				± 1.0	μA	$0.4\text{ V} \leq V_{OUT} \leq 2.4\text{ V}$
POWER SUPPLY CURRENT						
	I_{CC}		30	60	μA	Outputs unloaded, receivers enabled
			37	74	μA	DE = 0 V (disabled)
					μA	DE = 5 V (enabled)

TIMING SPECIFICATIONS

$V_{CC} = 5\text{ V} \pm 10\%$. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.

Table 2.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER						
Propagation Delay Input to Output	t_{PLH}, t_{PHL}	250		2000	ns	R_L differential = 54 Ω , $C_{L1} = C_{L2} = 100$ pF, see Figure 15, Figure 16
Driver Output Skew	t_{SKEW}		100	800	ns	R_L differential = 54 Ω , $C_{L1} = C_{L2} = 100$ pF, see Figure 15
Driver Rise/Fall Time	t_{DR}, t_{DF}	250		2000	ns	R_L differential = 54 Ω , $C_{L1} = C_{L2} = 100$ pF, see Figure 15, Figure 16
Driver Enable to Output Valid	t_{ZL}, t_{ZH}	250		2000	ns	$R_L = 500$ Ω , $C_L = 100$ pF, see Figure 12, Figure 18
Driver Disable Timing	t_{LZ}, t_{HZ}	300		3000	ns	$R_L = 500$ Ω , $C_L = 15$ pF, see Figure 12, Figure 18
Maximum Data Rate		250			kbps	
RECEIVER						
Propagation Delay Input to Output	t_{PLH}, t_{PHL}	250		2000	ns	$C_L = 15$ pF, see Figure 15, Figure 17
Skew	$ t_{PLH} - t_{PHL} $		100		ns	
Receiver Enable	t_{EN1}		10	50	ns	$R_L = 1$ k Ω , $C_L = 15$ pF, see Figure 14, Figure 19
Receiver Disable	t_{EN2}		10	50	ns	$R_L = 1$ k Ω , $C_L = 15$ pF, see Figure 14, Figure 19
Maximum Data Rate		250			kbps	

ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 3.

Parameter	Rating
V_{CC}	7 V
Inputs	
Driver Input (DI)	$-0.3\text{ V to }V_{CC} + 0.3\text{ V}$
Control Inputs (DE, $\overline{\text{RE}}$)	$-0.3\text{ V to }V_{CC} + 0.3\text{ V}$
Receiver Inputs (A, B)	$-14\text{ V to }+14\text{ V}$
Outputs	
Driver Outputs	$-14\text{ V to }+12.5\text{ V}$
Receiver Output	$-0.5\text{ V to }V_{CC} + 0.5\text{ V}$
Power Dissipation 8-Lead SOIC	520 mW
θ_{JA} , Thermal Impedance	110°C/W
Power Dissipation 14-Lead SOIC	800 mW
θ_{JA} , Thermal Impedance	120°C/W
Operating Temperature Range	
Industrial (A Version)	$-40^\circ\text{C to }+85^\circ\text{C}$
Storage Temperature Range	$-65^\circ\text{C to }+150^\circ\text{C}$
Lead Temperature (Soldering, 10 sec)	300°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C
ESD Protection on All Pins	
Human Body Model (HBM)	$\pm 4\text{ kV}$

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

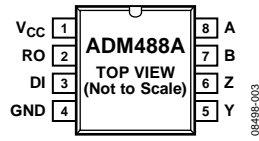


Figure 3. ADM488A SOIC_N and MSOP Pin Configuration

Table 4. ADM488A Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{CC}	Power Supply, 5 V ± 10%.
2	RO	Receiver Output. When A > B by 200 mV, RO = high. If A < B by 200 mV, RO = low.
3	DI	Driver Input. A logic low on DI forces Y low and Z high, whereas a logic high on DI forces Y high and Z low.
4	GND	Ground Connection, 0 V.
5	Y	Noninverting Driver, Differential Output Y.
6	Z	Inverting Driver, Differential Output Z.
7	B	Inverting Receiver, Input B.
8	A	Noninverting Receiver, Input A.

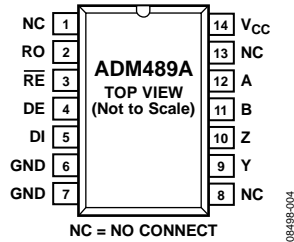


Figure 4. ADM489A SOIC_N Pin Configuration

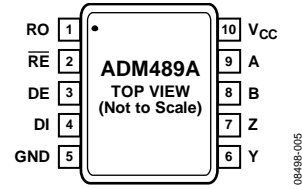


Figure 5. ADM489A MSOP Pin Configuration

Table 5. ADM489A Pin Function Descriptions

Pin No.		Mnemonic	Description
SOIC_N	MSOP		
1, 8, 13	N/A ¹	NC	No Connect. No connections are required to this pin.
2	1	RO	Receiver Output. When enabled, if A > B by 200 mV, RO = high. If A < B by 200 mV, RO = low.
3	2	RE	Receiver Output Enable. A low level enables the receiver output, RO. A high level places the ADM489A in a high impedance state.
4	3	DE	Driver Output Enable. A high level enables the driver differential outputs (Y and Z). A low level places the ADM489A in a high impedance state.
5	4	DI	Driver Input. When the driver is enabled, a logic low on DI forces Y low and Z high, whereas a logic high on DI forces Y high and Z low.
6, 7	5	GND	Ground Connection, 0 V.
9	6	Y	Noninverting Driver, Differential Output Y.
10	7	Z	Inverting Driver, Differential Output Z.
11	8	B	Inverting Receiver, Input B.
12	9	A	Noninverting Receiver, Input A.
14	10	V _{CC}	Power Supply, 5 V ± 10%.

¹ N/A means not applicable.

TYPICAL PERFORMANCE CHARACTERISTICS

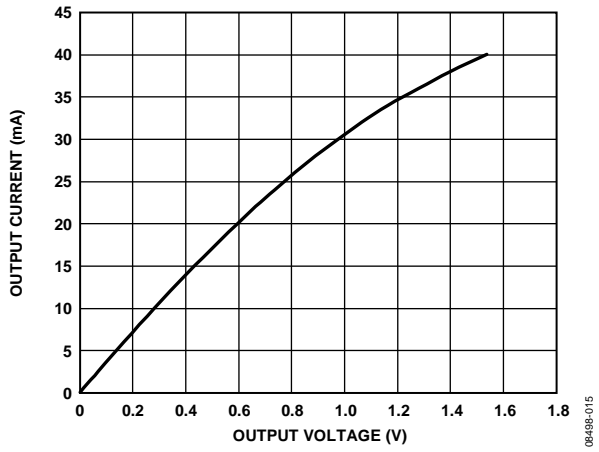


Figure 6. Output Current vs. Receiver Output Low Voltage

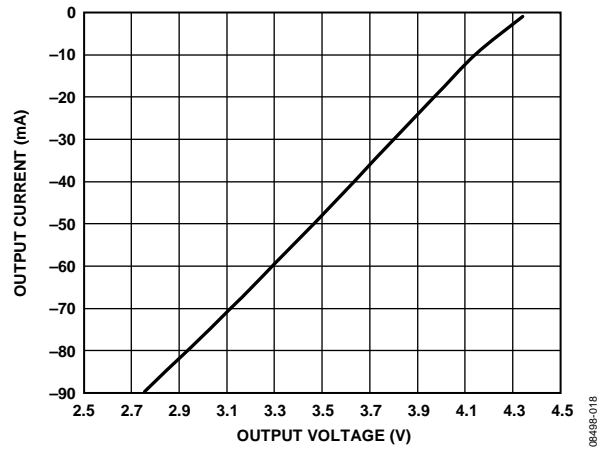


Figure 9. Output Current vs. Driver Output High Voltage

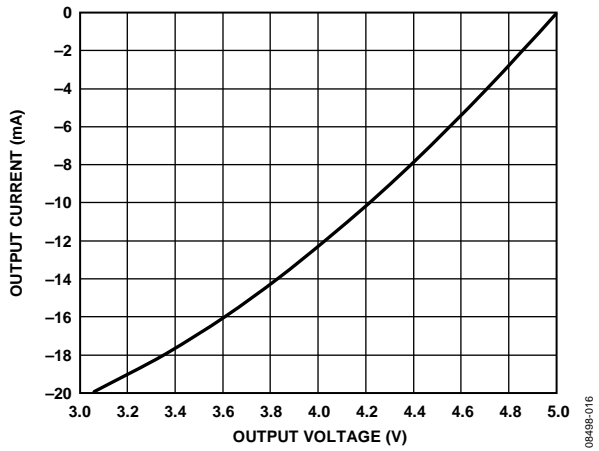


Figure 7. Output Current vs. Receiver Output High Voltage

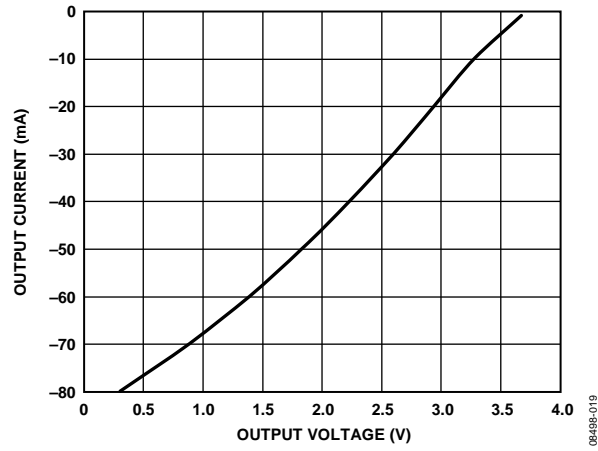


Figure 10. Output Current vs. Driver Differential Output Voltage

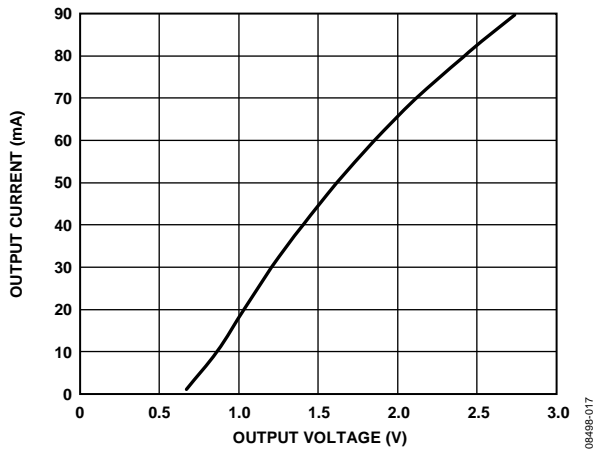


Figure 8. Output Current vs. Driver Output Low Voltage

TEST CIRCUITS

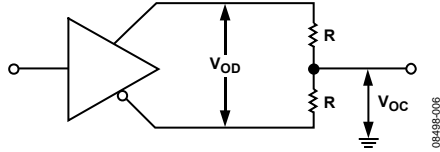


Figure 11. Driver Voltage Measurement Test Circuit

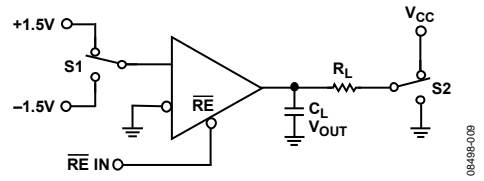


Figure 14. Receiver Enable/Disable Test Circuit

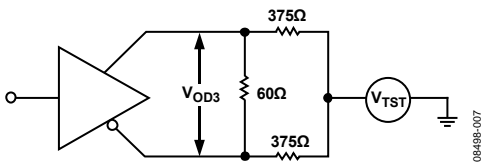


Figure 12. Driver Enable/Disable Test Circuit

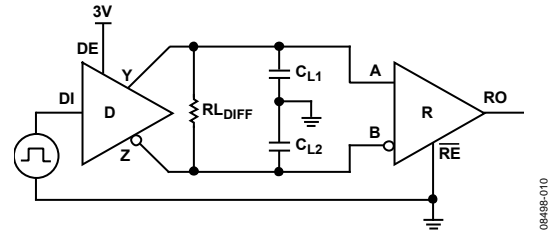


Figure 15. Driver/Receiver Propagation Delay Test Circuit

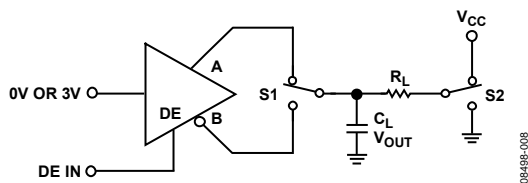


Figure 13. Driver Voltage Measurement Test Circuit

SWITCHING CHARACTERISTICS

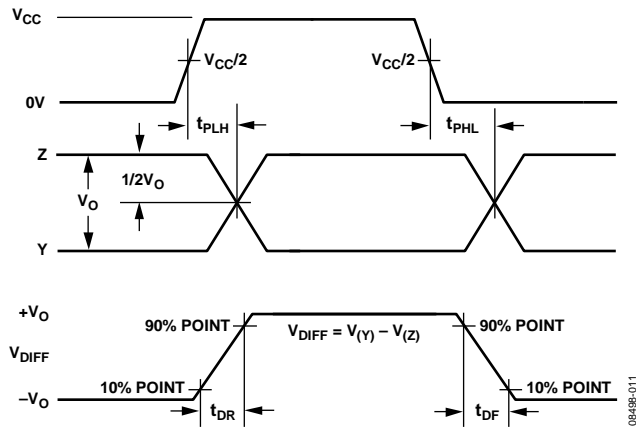


Figure 16. Driver Propagation Delay, Rise/Fall Timing

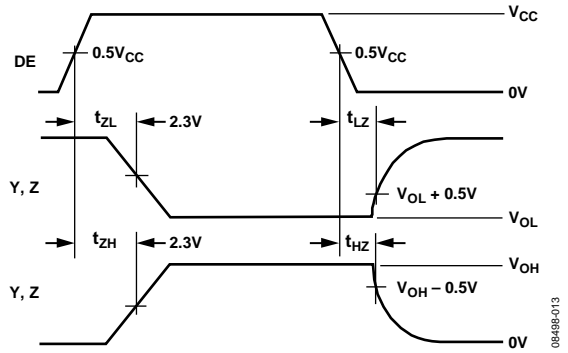


Figure 18. Driver Enable/Disable Timing

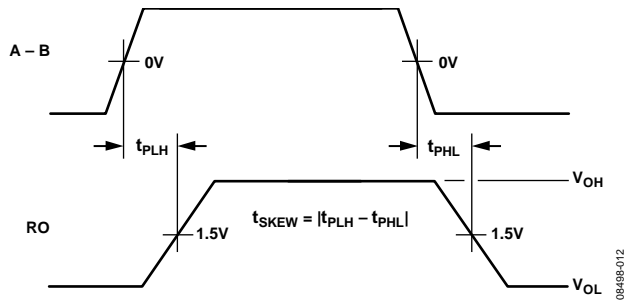


Figure 17. Receiver Propagation Delay

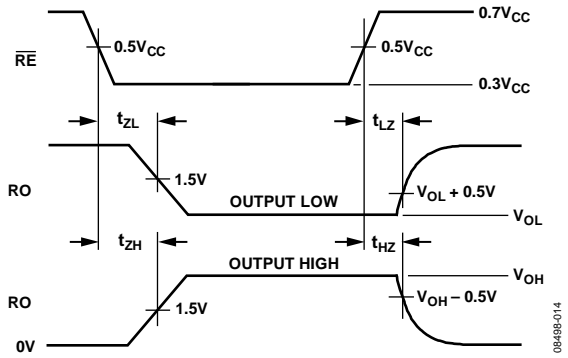


Figure 19. Receiver Enable/Disable Timing

THEORY OF OPERATION

The ADM488A/ADM489A are ruggedized RS-485 transceivers that operate from a single 5 V supply. They contain protection against radiated and conducted interference and are ideally suited for operation in electrically harsh environments or where cables can be plugged/unplugged. They are also immune to high RF field strengths without special shielding precautions.

The ADM488A/ADM489A are intended for balanced data transmission and comply with both EIA RS-485 and RS-422 standards. They contain a differential line driver and a differential line receiver, and are suitable for full-duplex data transmission.

The input impedance on the ADM488A/ADM489A is 12 kΩ, allowing up to 32 transceivers on the differential bus. The ADM488A/ADM489A operate from a single 5 V ± 10% power supply. A thermal shutdown circuit prevents excessive power dissipation caused by bus contention or by output shorting. This feature forces the driver output into a high impedance state if, during fault conditions, a significant temperature increase is detected in the internal driver circuitry.

The receiver contains a fail-safe feature that results in a logic high output state if the inputs are unconnected (floating).

The ADM488A/ADM489A can transmit at data rates up to 250 kbps. Figure 20 shows a typical application for the ADM488A/ADM489A, a full-duplex link where data transfers at rates of up to 250 kbps. A terminating resistor is shown at both ends of the link. This termination is not critical because

the slew rate is controlled by the ADM488A/ADM489A and reflections are minimized.

The communications network can be extended to include multipoint connections, as shown in Figure 22. As many as 32 transceivers can be connected to the bus.

Table 6 and Table 7 show the truth tables for transmitting and receiving.

Table 6. Transmitting Truth Table

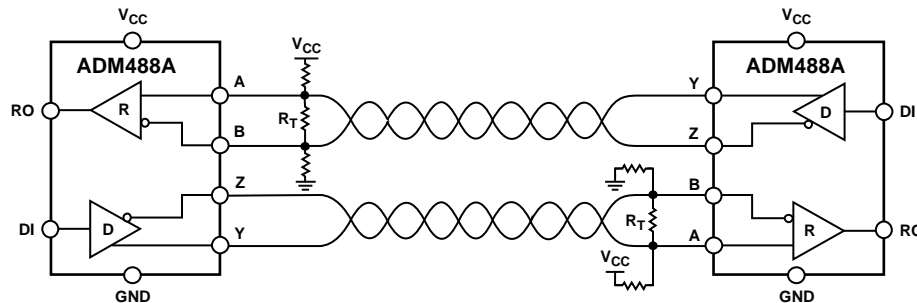
Inputs			Outputs	
RE	DE	DI	Z	Y
X ¹	1	1	0	1
X ¹	1	0	1	0
0	0	X ¹	High-Z	High-Z
1	0	X ¹	High-Z	High-Z

¹ X is don't care.

Table 7. Receiving Truth Table

Inputs			Output
RE	DE	A to B	RO
0	0	≥ +0.2 V	1
0	0	≤ -0.2 V	0
0	0	Inputs open circuit	1
1	0	X ¹	High-Z

¹ X is don't care.

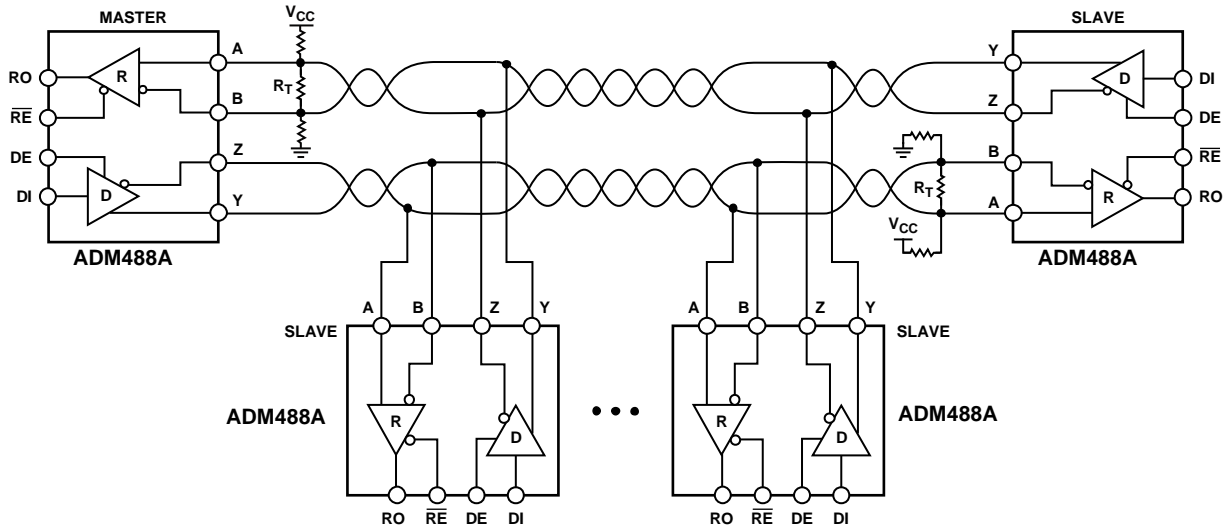


NOTES
1. MAXIMUM NUMBER OF NODES = 32.

Figure 20. ADM488A/ADM489A Full-Duplex Data Link

084488-021

MAXIMUM NUMBER OF NODES = 32



NOTES
 1. R_T IS EQUAL TO THE CHARACTERISTIC IMPEDANCE OF THE CABLE.

Figure 21. Typical RS-485 Full-Duplex Application

08488-023

APPLICATIONS INFORMATION

DIFFERENTIAL DATA TRANSMISSION

Differential data transmission reliably transmits data at high rates over long distances and through noisy environments. Differential transmission nullifies the effects of ground shifts and noise signals, which appear as common-mode voltages on the line. Two main standards that specify the electrical characteristics of transceivers used in differential data transmission are approved by the EIA.

The RS-422 standard specifies data rates up to 10 Mbps and line lengths up to 4000 ft. A single driver can drive a transmission line with up to 10 receivers.

To cater to true multipoint communications, the RS-485 standard was defined to meet or exceed the requirements of RS-422. It also allows up to 32 drivers and 32 receivers to be connected to a single bus. An extended common-mode range of -7 V to $+12\text{ V}$ is defined. The most significant difference between the RS-422 and RS-485 is that the RS-485 drivers can be disabled, thereby allowing up to 32 receivers to be connected to a single line. Only one driver should be enabled at a time, but the RS-485 standard contains additional specifications to guarantee device safety in the event of line contention.

CABLE AND DATA RATE

The transmission line of choice for RS-485 communications is a twisted pair. Twisted pair cable tends to cancel common-mode noise and causes cancellation of the magnetic fields generated by the current flowing through each wire, thereby reducing the effective inductance of the pair.

The ADM488A/ADM489A are designed for bidirectional data communications on multipoint transmission lines. A typical application with a multipoint transmission network is illustrated in Figure 22. An RS-485 transmission line can have up to 32 transceivers on the bus. Only one driver can transmit at a particular time, but multiple receivers can be simultaneously enabled.

As with any transmission line, it is important to minimize reflections. This can be achieved by terminating the extreme ends of the line using resistors equal to the characteristic impedance of the line. Keep stub lengths of the main line as short as possible. A properly terminated transmission line appears purely resistive to the driver.

Table 8. Comparison of RS-422 and RS-485 Interface Standards

Specification	RS-422	RS-485
Transmission Type	Differential	Differential
Maximum Data Rate	10 Mbps	10 Mbps
Maximum Cable Length	4000 ft.	4000 ft.
Minimum Driver Output Voltage	$\pm 2\text{ V}$	$\pm 1.5\text{ V}$
Driver Load Impedance	$100\ \Omega$	$54\ \Omega$
Receiver Input Resistance	4 k Ω minimum	12 k Ω minimum
Receiver Input Sensitivity	$\pm 200\text{ mV}$	$\pm 200\text{ mV}$
Receiver Input Voltage Range	-7 V to $+7\text{ V}$	-7 V to $+12\text{ V}$
Number of Drivers/Receivers per Line	1/10	32/32

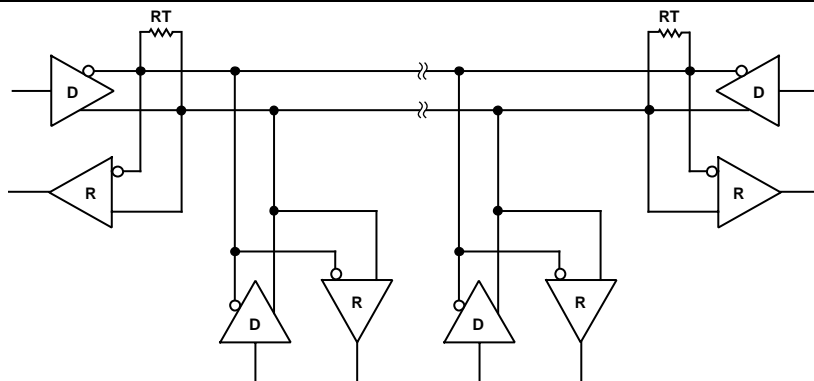
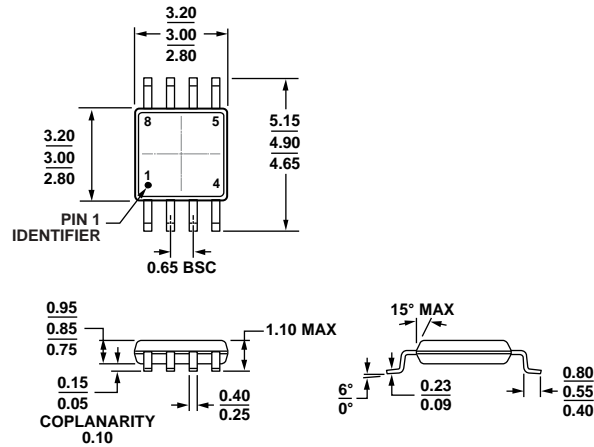


Figure 22. Typical RS-485 Network

09488-022

OUTLINE DIMENSIONS

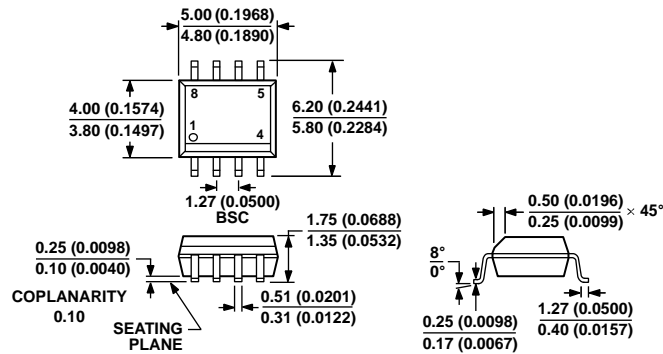


COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 23. 8-Lead Mini Small Outline Package [MSOP] (RM-8)

Dimensions shown in millimeters

10-07-2009-B



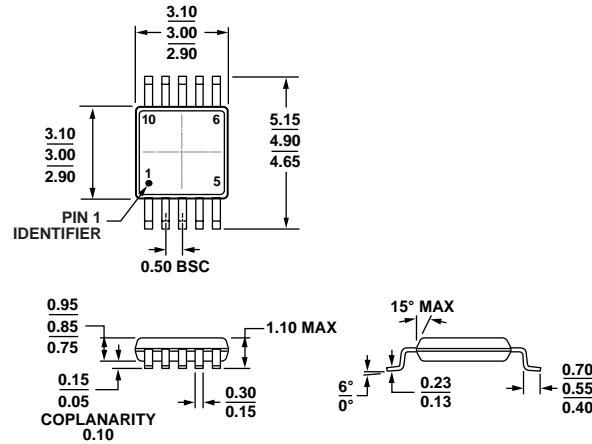
COMPLIANT TO JEDEC STANDARDS MS-012-AA

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 24. 8-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-8)

Dimensions shown in millimeters and (inches)

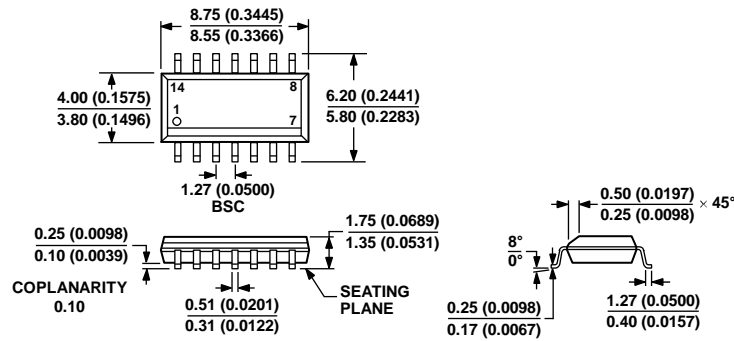
012407-A



COMPLIANT TO JEDEC STANDARDS MO-187-BA

Figure 25. 10-Lead Mini Small Outline Package [MSOP] (RM-10)
Dimensions shown in millimeters

001708-A



COMPLIANT TO JEDEC STANDARDS MS-012-AB

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 26. 14-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-14)
Dimensions shown in millimeters and (inches)

060608-A

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Branding
ADM488ABRMZ	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	FOF
ADM488ABRMZ-REEL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	FOF
ADM488ABRZ	-40°C to +85°C	8-Lead Standard Small Outline Package, Narrow Body [SOIC_N]	R-8	
ADM488ABRZ-REEL7	-40°C to +85°C	8-Lead Standard Small Outline Package, Narrow Body [SOIC_N]	R-8	
ADM489ABRMZ	-40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	FOG
ADM489ABRMZ-REEL7	-40°C to +85°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	FOG
ADM489ABRZ	-40°C to +85°C	14-Lead Standard Small Outline Package, Narrow Body [SOIC_N]	R-14	
ADM489ABRZ-REEL7	-40°C to +85°C	14-Lead Standard Small Outline Package, Narrow Body [SOIC_N]	R-14	

¹ Z = RoHS Compliant Part.

NOTES

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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